**Preferred Devices** 

## **Surface Mount Ultrafast Power Rectifiers**

Ideally suited for high voltage, high frequency rectification, or as free wheeling and protection diodes in surface mount applications where compact size and weight are critical to the system.

- Small Compact Surface Mountable Package with J-Bend Leads
- Rectangular Package for Automated Handling
- High Temperature Glass Passivated Junction
- Low Forward Voltage Drop (0.71 Volts Max @ 1.0 A, T<sub>J</sub> = 150°C)

#### **Mechanical Characteristics:**

- Case: Epoxy, Molded
- Weight: 70 mg (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped in 12 mm Tape and Reel, 5000 units per reel
- Polarity: Polarity Band Indicates Cathode Lead
- ESD Protection: Human Body Model > 4000 V (Class 3) Machine Model > 400 V (Class C)
- Marking: U4C, U4D

#### **MAXIMUM RATINGS**

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage MURA115T3 MURA120T3	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	150 200	V
Average Rectified Forward Current @ T <sub>L</sub> = 155°C @ T <sub>L</sub> = 135°C	I <sub>F(AV)</sub>	1.0 2.0	A
Non-Repetitive Peak Surge Current (Surge Applied at Rated Load Conditions Halfwave, Single Phase, 60 Hz)	I <sub>FSM</sub>	40	A
Operating Junction Temperature Range	TJ	- 65 to +175	°C

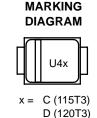


#### ON Semiconductor®

http://onsemi.com

# ULTRAFAST RECTIFIERS 1 AMPERE 100-200 VOLTS





#### **ORDERING INFORMATION**

Device	Package	Shipping	
MURA115T3	SMA	5000/Tape & Reel	
MURA120T3	SMA	5000/Tape & Reel	

**Preferred** devices are recommended choices for future use and best overall value

#### THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction to Lead (T <sub>L</sub> = 25°C) (Note 1)	Psi <sub>JL</sub> (Note 2)	24	°C/W
Thermal Resistance, Junction to Ambient (Note 1)	$R_{\theta JA}$	216	

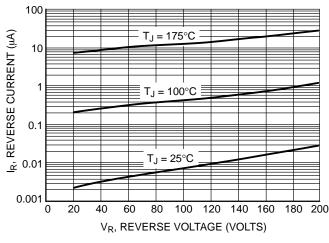
#### **ELECTRICAL CHARACTERISTICS**

Maximum Instantaneous Forward Voltage (Note 3) $(i_F = 1.0 \text{ A}, T_J = 25^{\circ}\text{C})$ $(i_F = 1.0 \text{ A}, T_J = 150^{\circ}\text{C})$	VF	0.875 0.71	Volts
Maximum Instantaneous Reverse Current (Note 3) (Rated dc Voltage, $T_J = 25^{\circ}C$ ) (Rated dc Voltage, $T_J = 150^{\circ}C$ )	i <sub>R</sub>	2.0 50	μΑ
Maximum Reverse Recovery Time (i <sub>F</sub> = 1.0 A, di/dt = 50 A/µs)	t <sub>rr</sub>	35	ns

100

10

- Rating applies when surface mounted on the minimum pad size recommended, PC Board FR-4.
- In compliance with JEDEC 51, these values (historically represented by  $R_{\theta,JL}$ ) are now referenced as Psi<sub>JL</sub>.
- 3. Pulse Test: Pulse Width = 300  $\mu$ s, Duty Cycle  $\leq$  2.0%.

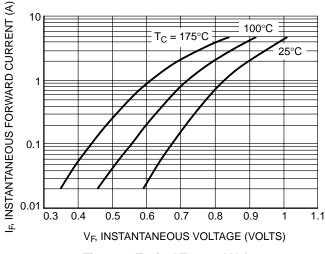


IR, REVERSE CURRENT (MA) 10  $T_J = 100^{\circ}C$  $T_J = 25^{\circ}C$ 0.1 20 100 120 140 160 180 200 V<sub>R</sub>, REVERSE VOLTAGE (VOLTS)

T<sub>.1</sub> = 175°C

**Figure 1. Typical Reverse Current** 

Figure 2. Maximum Reverse Current



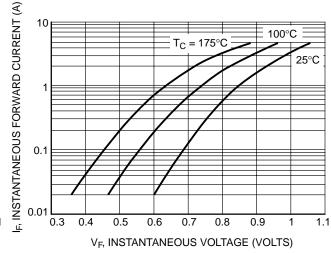


Figure 3. Typical Forward Voltage

Figure 4. Maximum Forward Voltage

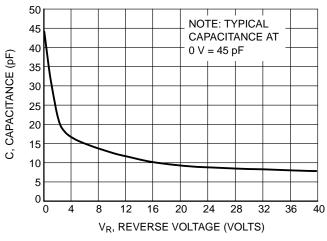


Figure 5. Typical Capacitance

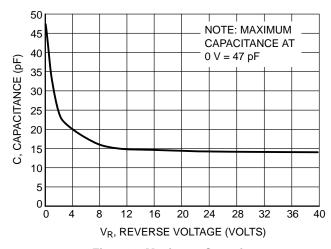


Figure 6. Maximum Capacitance

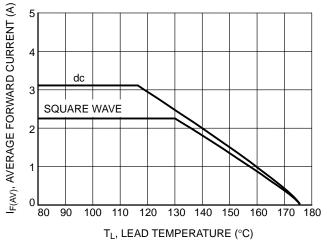


Figure 7. Current Derating, Lead

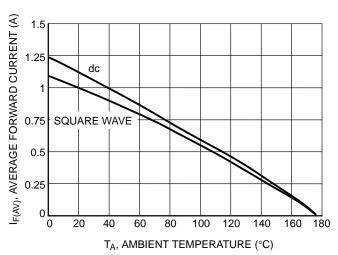


Figure 8. Current Derating, Ambient (FR-4 Board with Minimum Pad)

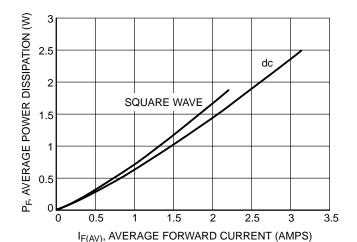
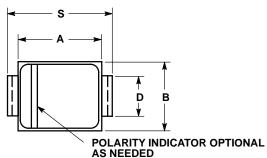


Figure 9. Power Dissipation

#### **PACKAGE DIMENSIONS**

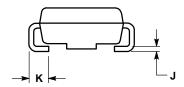
#### SMA CASE 403D-02 ISSUE A

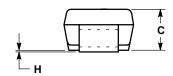


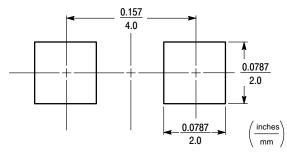
#### NOTES:

- DIMENSIONING AND TOLERANCING PER ANSI
   VIA 5M 1000
- Y14.5M, 1982.
  2. CONTROLLING DIMENSION: INCH.
- 403D-01 OBSOLETE, NEW STANDARD IS 403D-02.

	INCHES		INCHES MILLIMETER	
DIM	MIN	MAX	MIN	MAX
Α	0.160	0.180	4.06	4.57
В	0.090	0.115	2.29	2.92
С	0.075	0.095	1.91	2.41
D	0.050	0.064	1.27	1.63
H	0.002	0.006	0.05	0.15
_	0.006	0.016	0.15	0.41
K	0.030	0.060	0.76	1.52
S	0.190	0.220	4.83	5 59







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